

1.0x0.5mm SMD CHIP LED LAMP

APHS1005SYCK

SUPER BRIGHT YELLOW

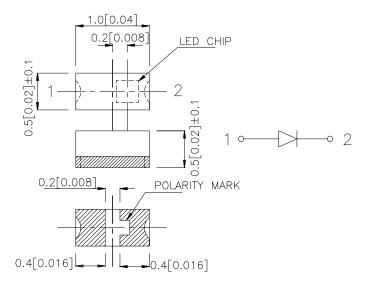
Features

- •1.0mmx0.5mmSMTLED, 0.5mmTHICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.

Description

The Super Bright Yellow source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.
- 3. Lead spacing is measured where the lead emerge package.
- 4. Specifications are subject to change without notice.

SPEC NO: CDA0313 APPROVED : J. Lu REV NO: V.1 CHECKED:

DATE: OCT/24/2001 DRAWN: Y.F.XU **PAGE: 1 OF 4**



Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 20 mA		Viewing Angle
			Min.	Тур.	201/2
APHS1005SYCK	SUPER BRIGHT YELLOW (InGaAIP)	WATER CLEAR	30	60	120°

Note:

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Yellow	590		nm	IF=20mA
λD	Dominate Wavelength	Super Bright Yellow	590		nm	IF=20mA
Δλ1/2	Spectral Line Halfwidth	Super Bright Yellow	20		nm	IF=20mA
С	Capacitance	Super Bright Yellow	20		pF	VF=0V;f=1MHz
V _F	Forward Voltage	Super Bright Yellow	2.0	2.5	V	IF=20mA
I _R	Reverse Current	Super Bright Yellow		10	uA	VR = 5V

Absolute Maximum Ratings at T_A=25°C

Parameter	Super Bright Yellow	Units
Power dissipation	125	mW
DC Forward Current	30	mA
Peak Forward Current [1]	175	mA
Reverse Voltage	5	V
Operating Temperature	-40°C To +85°C	
Storage Temperature	-40°C To +85°C	

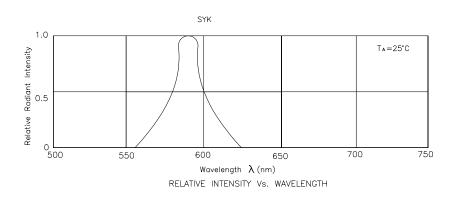
Note:

SPEC NO: CDA0313 REV NO: V.1 DATE: OCT/24/2001 PAGE: 2 OF 4
APPROVED: J. Lu CHECKED: DRAWN: Y.F.XU

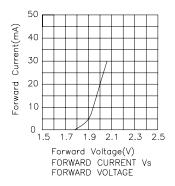
^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

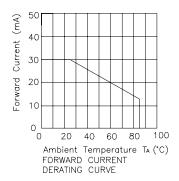
^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

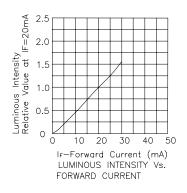


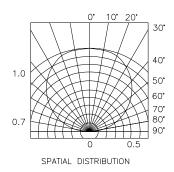


Super Bright Yellow APHS1005SYCK









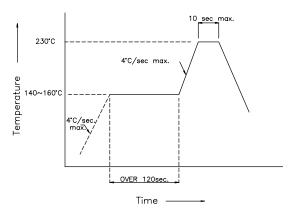
SPEC NO: CDA0313 APPROVED: J. Lu REV NO: V.1 CHECKED:

DATE: OCT/24/2001 DRAWN: Y.F.XU PAGE: 3 OF 4

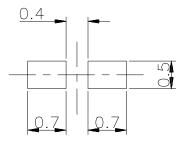


APHS1005SYCK SMT Reflow Soldering Instructions

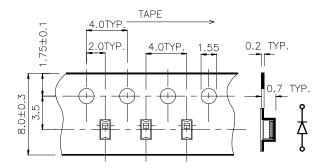
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units:mm)



Tape Specifications (Units:mm)



PAGE: 4 OF 4

SPEC NO: CDA0313 REV NO: V.1 DATE: OCT/24/2001
APPROVED: J. Lu CHECKED: DRAWN: Y.F.XU